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Accept	
Home > Products > DRAM > MT53B512M32D2DS 062 AIT	8⁺ in ¥ f
MT53B512M32D2DS-062 AIT	
DATA SHEETS (2) SPECS SIM SOFTWARE CERTIFICATES DOCUMENTATION & SUPPORT OF A SAME TO SHEET (2) SOFTWARE (2) SOFTWARE (2) SOFTWARE (2) SOFTWARE (2) SHEET (5) SOFTWARE (2) SHEET (5) SUPPORT (5) SUPPOR	TS SPECS MOD
Data Sheets (2)	
Data Sheet	
200-Ball Z91M Automotive LPDDR4 SDRAM	Automotive DRAM
MT53B256M32D1, MT53B512M32D2	Embedded Mobile LPDDR4
File Type: PDFUpdated: 05/2018	DOWNLOAD
Data Sheet	
Production Data Sheet: 200-Ball Z01M LPDDR4 SDRAM Automotive	Automotive DRAM
MT53B256M32D1NP-062 AAT:C, MT53B256M32D1NP-062 AIT:C, MT53B256M32D1NP-062 AUT:C, MT53B512M32D2NP-062 AAT:C, MT53B512M32D2NP-062 AIT:C, MT53B512M32D2NP-062 AUT:C	Mobile LPDDR4
File Type: PDFUpdated: 05/2018	DOWNLOAD



Orderable Parts for: MT53B512M32D2DS-062 AIT

FBGA SPD Chipset PLP Media Code Data Validation Date Part MT53B512M32D2DS-062 Sampling N/A D9VXR N/A N/A No N/A AIT:C

SEE ALL 16GB LPDRAM PARTS

Detailed Specifications

Down	Technology	LPDDR4	Density	16Gb	Part Status	Sampling	RoHS	Yes
DOWI	noaueu nonn Anow.	com.						

Depth	512Mb	Width	x32	Voltage	1.1V	Package	WFBGA
Pin Count	200-ball	Clock Rate	1600 MHz	Data Rate	DDR4-3200	Cycle Time	
Op. Temp.	-40C to +95C	Brand	Micron				

Sim Models & Software

Sim Models

IBIS				
Z01M Mobile LPDDR4 SDRAM, Die Rev. C, SDP, DDP, QDP, 200b, 272b, 366b, 432b				
File Type: ZIP Updated: 07/05/2018	DOWNLOAD			
HSpice 🔒				
Z01M HSPICE (ZIP)	DRAM Mobile LPDDR4			
Z01M Mobile LPDDR4 SDRAM, Die Rev. C				
File Type: ZIP Updated: 03/15/2017	DOWNLOAD			

RoHS Certificates

RoHS Certificates RoHS Certificate of Compliance (PDF) Part-specific certification of how this product meets the requirements of the current DIRECTIVE 2002/95/EC, a.k.a. Restriction of Hazardous Substances (RoHS) Directive. File Type: (PDF) Updated: 07/2018 Cohna RoHS Certificate (PDF) Part-specific certification as required by China's Management Methods for Controlling Pollution by Electronic Information Products. File Type: (PDF) Updated: 07/2018

Documentation & Support

See All Documentation

Technical Notes

SEARCH (81) TECHNICAL NOTES

Technical Notes		
TN-ED-04: GDDR6 Design Guide (PDF)		DRAM GDDR6N
This technical note is designed to help designers with established packaging, handling and testing integrity, as well as standard GDDR6 DRAM featu	. It outlines best practices for signal and power	Graphics Performance
File Type: PDF Updated: 07/30/2018		DOWNLOAD
Technical Notes		
Technical Notes	idelines (PDF)	DRAM
		Mobile LPDDR4
(TN-53-06) Proven layout and routing techniques using point-to-point DRAM interfaces in side by s transmission line theory and Micron design expo note		
File Type: PDF Updated: 03/16/2018		DOWNLOAD

Parts with the same Data Sheet (5)

MT53B512M32D2DS-062 AIT (Current)		MT53B256M32D1DS-062 AA T	MT53B256M32D1DS-062 AIT	MT53B256M32D1DS-062 AU T	
Part Status	Sampling	Contact Factory	Sampling	Sampling	
Technology	LPDDR4	LPDDR4	LPDDR4	LPDDR4	
Density 16Gb		8Gb	8Gb	8Gb	
RoHS	Yes	Yes	Yes	Yes	
Depth	512Mb	256Mb	256Mb	256Mb	
Width	x32	x32	x32	x32	
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V o	Voltage1.1VPackageWFBGAPin Count200-ballClock Rate1600 MHz		1.1V	1.1V	1.1V
Pac			WFBGA	WFBGA	WFBGA
Pin			200-ball	200-ball	200-ball
Cloc			1600 MHz	1600 MHz	1600 MHz
Dat	Data Rate DDR4-3200		DDR4-3200	DDR4-3200	DDR4-3200
	Сус	le Time			
Op.	. Temp.	-40C to +95C	-40C to +105C	-40C to +95C	-40C to +125C
Ві	Brand	Micron	Micron	Micron	Micron

MT53B512M32D2DS-062 AIT

(Current)

Part Status	Sampling		Where to	Buv	
Technology	LPDDR4		- OR -	Check with Distributors	
Density	16Gb			Your Region: Americas 💌	
RoHS	Yes				
Depth	512Mb				
Width	x32				_
Voltage	1.1V				
Package	WFBGA				-
Pin Count	200-ball			See All Distributors	
Clock Rate	1600 MHz				
Data Rate	DDR4-3200	ns		Support About	
	Cycle Time	istry ive Memory Solutions	By Application Client Cloud	Contact Us Our Company Support Documentation and News and Events	
Op. Temp.	-40C to +95C	er ed Memory Solutions	Data Center Storage Data Security	Downloads Micron Blogs Sales Support Jobs	
Brand	Micron	Solutions Services rial Memory Solutions	Enterprise SSD Storage Supercomputing Memor	Authorized Sales History of Innovation	
Memory Cards Solid State Driv	Mobile	Memory Solutions rking Innovations		Legal Our Commitment Site Map Investor Relations Surplus Equipment Suppliers	





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